

D4SBN20

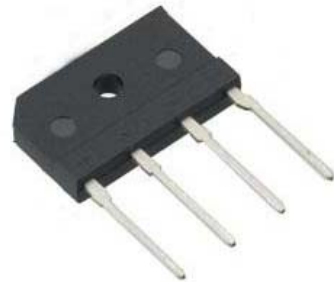
Bridge Diodes
200V, 4A

Feature

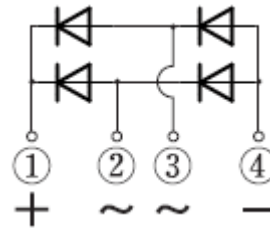
- Compact SIP
- SBD Bridge
- High Recovery Speed
- Low V_F
- Pb free terminal
- RoHS:Yes

OUTLINE

Package (House Name): 3S



Equivalent circuit



Absolute Maximum Ratings (unless otherwise specified : $T_C=25^{\circ}\text{C}$)

| Item | Symbol | Conditions | Ratings | Unit |
|---------------------------------|-----------|---|------------|-------------------------|
| Storage temperature | T_{stg} | | -55 to 150 | $^{\circ}\text{C}$ |
| Junction temperature | T_j | | -55 to 150 | $^{\circ}\text{C}$ |
| Repetitive peak reverse voltage | V_{RRM} | | 200 | V |
| Average forward current | $I_F(AV)$ | 50Hz sine wave, Resistance load, With heatsink, $T_C=103^{\circ}\text{C}$ | 4 | A |
| Average forward current | $I_F(AV)$ | 50Hz sine wave, Resistance load, On glass-epoxy substrate, $T_a=25^{\circ}\text{C}$ ※ | 2.2 | A |
| Surge forward current | I_{FSM} | 50Hz sine wave, Non-repetitive 1 cycle peak value, $T_j=25^{\circ}\text{C}$ | 60 | A |
| Dielectric strength | V_{dis} | Terminals to case, AC 1 minute | 2 | kV |
| Mounting torque | TOR | (Recommended torque : $0.5\text{N}\cdot\text{m}$) | 0.8 | $\text{N}\cdot\text{m}$ |

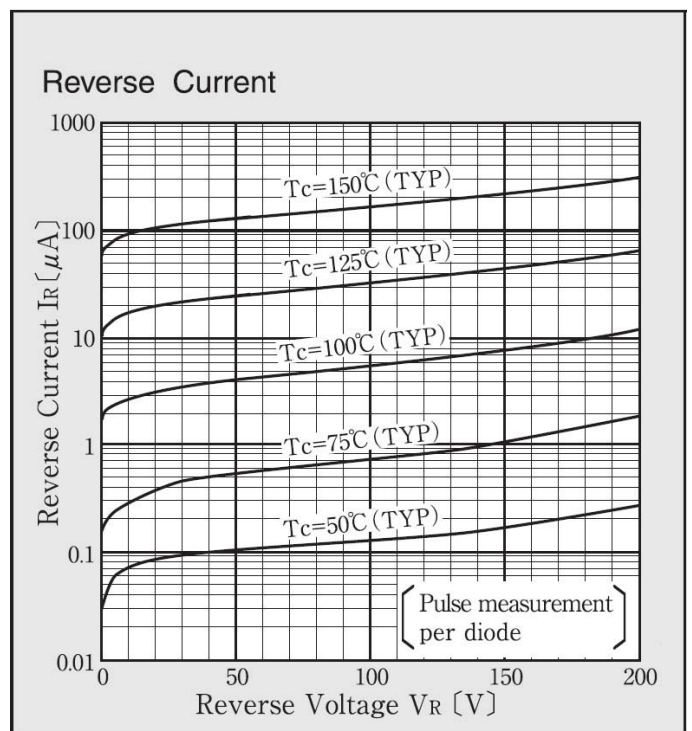
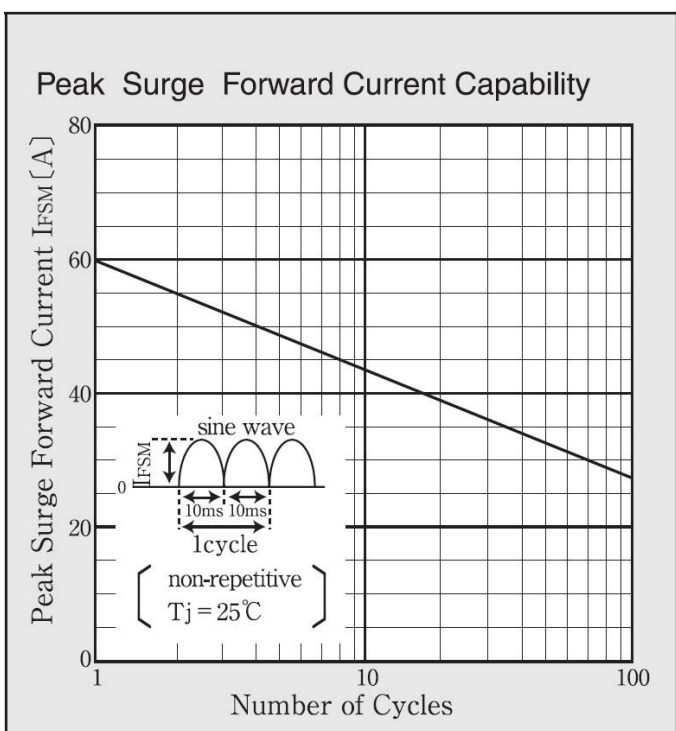
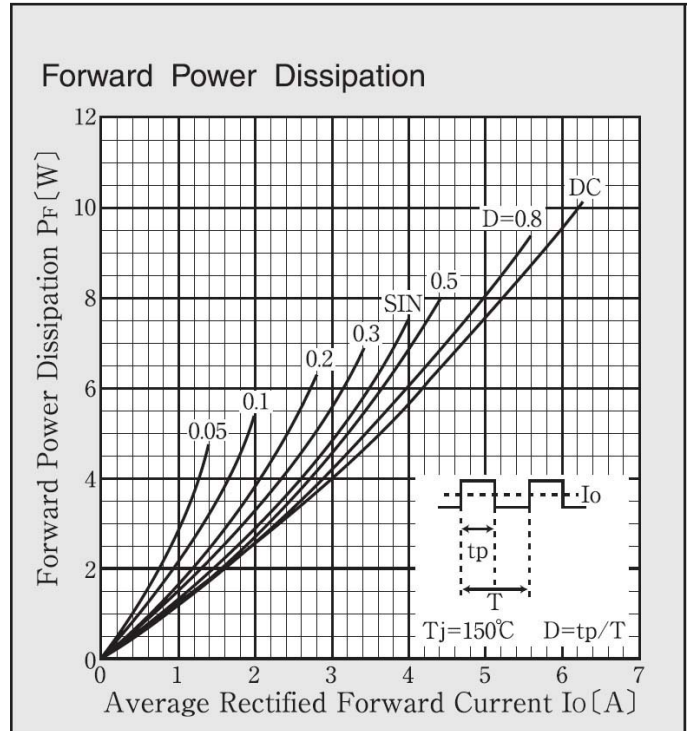
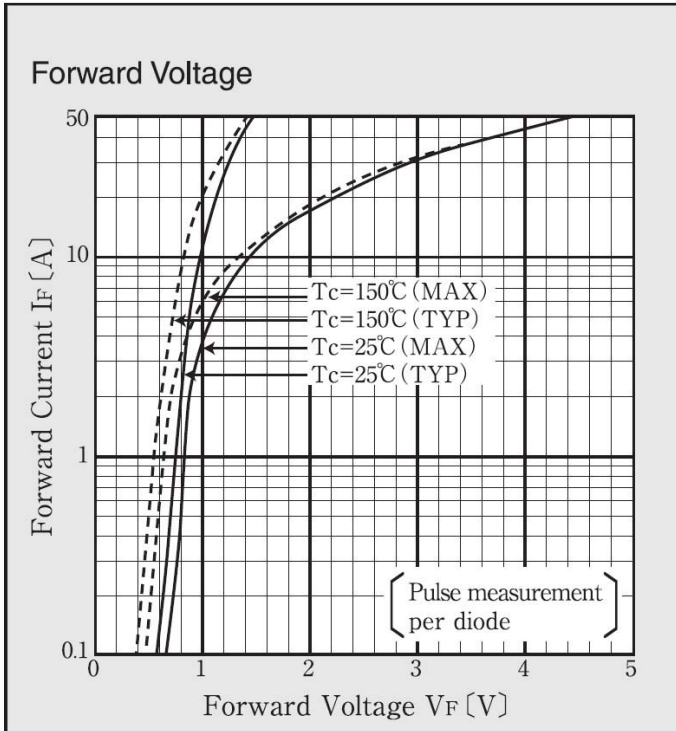
※ :See the original Specifications

Electrical Characteristics (unless otherwise specified : Tc=25°C)

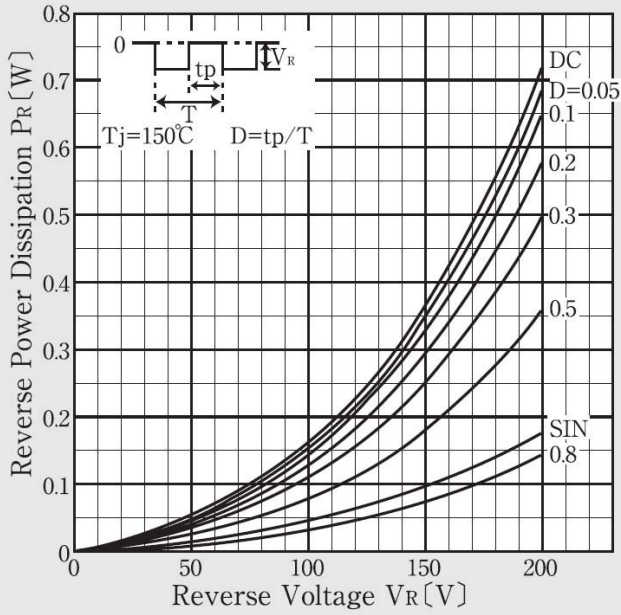
| Item | Symbol | Conditions | Ratings | | | Unit |
|--------------------|----------------------|--|---------|-----|-----|------|
| | | | MIN | TYP | MAX | |
| Forward voltage | V _F | I _F =2A, Pulse measurement, per diode | | | 0.9 | V |
| Reverse current | I _R | V _R =200V, Pulse measurement, per diode | | | 1.5 | μA |
| Total capacitance | C _t | f=1MHz, V _R =10V, per diode | | 60 | | pF |
| Thermal resistance | R _{th(j-c)} | Junction to case, With heatsink | | | 6 | °C/W |
| Thermal resistance | R _{th(j-l)} | Junction to lead, On glass-epoxy substrate ※ | | | 8 | °C/W |
| Thermal resistance | R _{th(j-a)} | Junction to ambient, On glass-epoxy substrate ※ | | | 35 | °C/W |

※ :See the original Specifications

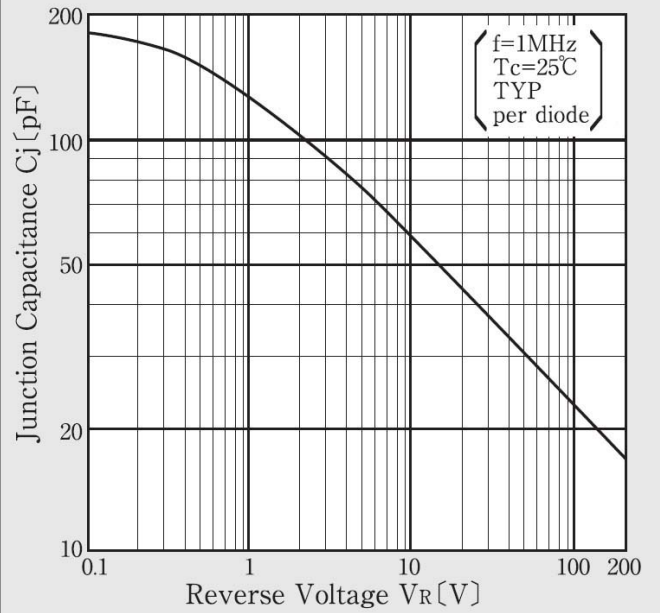
CHARACTERISTIC DIAGRAMS



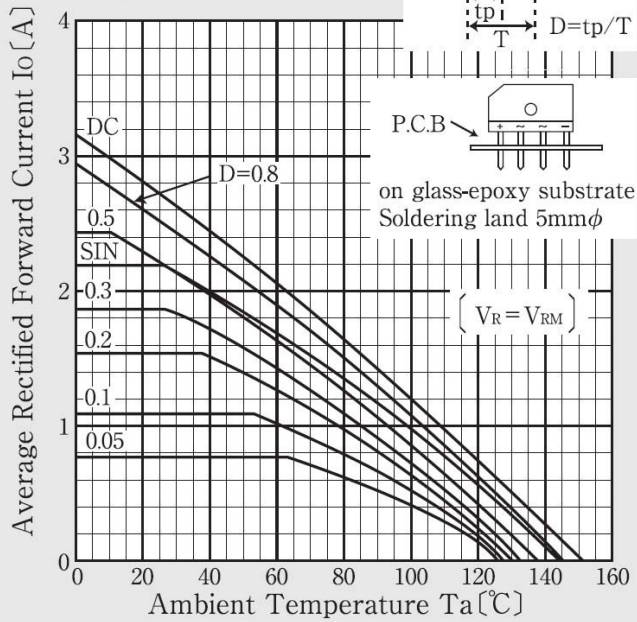
Reverse Power Dissipation



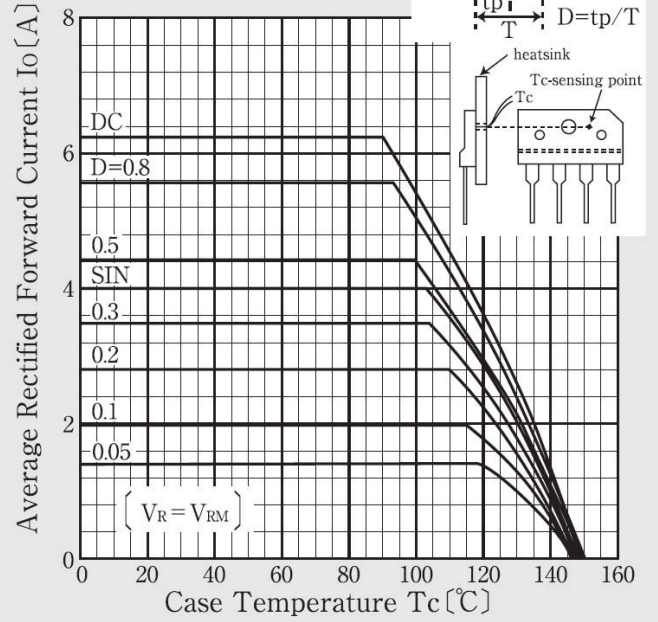
Junction Capacitance



Derating Curve

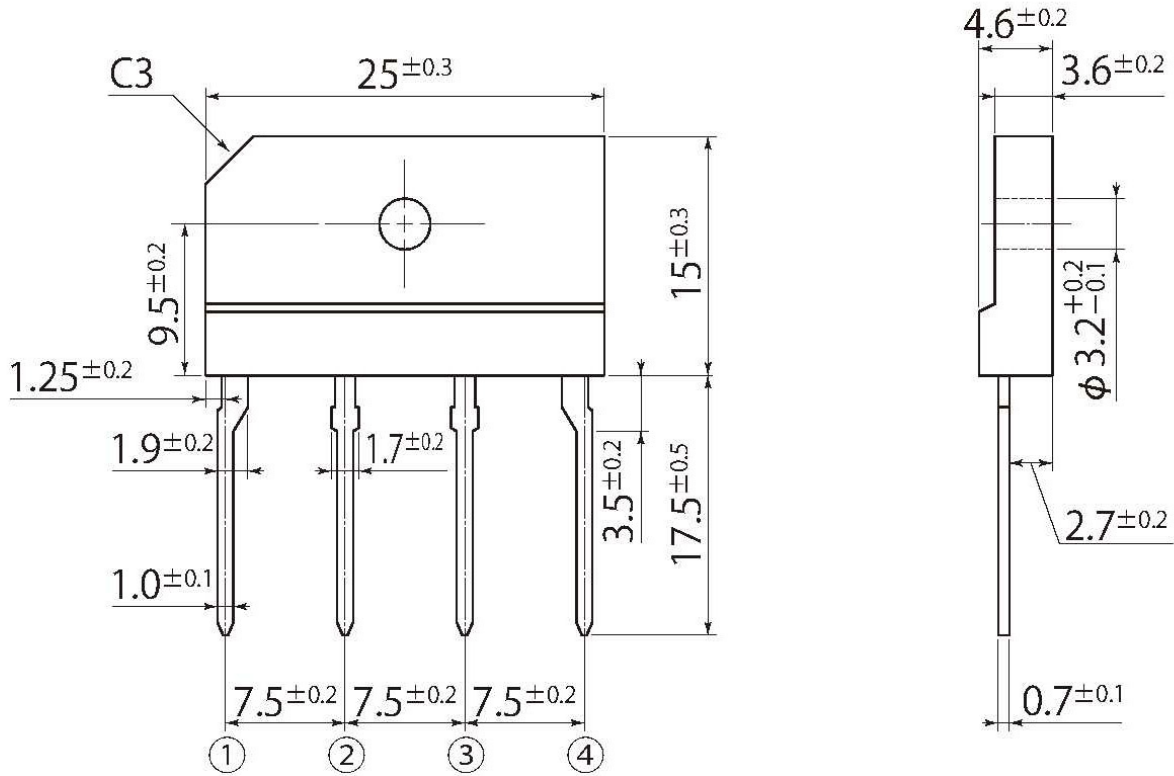


Derating Curve



D3

| | |
|------------|----|
| JEDEC Code | - |
| JEITA Code | - |
| House Name | 3S |



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